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FSDM0465RE, FSDM0565RE, FSDM07652RE **Green Mode Power Switch**

Features

- Internal Avalanche-Rugged SenseFET
- Advanced Burst-Mode Operation Consumes Under 1W at 240V_{AC} & 0.5W load
- Precision Fixed Operating Frequency (66kHz)
- Internal Start-up Circuit
- Improved Pulse-by-Pulse Current Limiting
- Over-Voltage Protection (OVP)
- Overload Protection (OLP)
- Internal Thermal Shutdown Function (TSD)
- Auto-Restart Mode
- Under-Voltage Lockout (UVLO) with hysteresis
- Low Operating Current (2.5mA)
- Built-in Soft-Start

Applications

- SMPS for LCD monitor and STE
- Adaptor

Description

The FSDM0465RE, FSDM0565RE and FSDM07652RE are an integrated Pulse Width Modulator (PWM) and SenseFET specifically designed for high-performance offline Switch Mode Power Supplies (SMPS) with minimal external components. This device is an integrated high-voltage power-switching regulator that combines an avalanche-runged SenseFET with a current mode PWM control block. The PWM controller includes an integrated fixed-frequency oscillator, undervoltage lockout, leading-edge blanking (LEB), optimized gate driver, internal soft-start, temperature-compensated precise-current sources for a loop compensation, and self protection circuitry. Compared with a discrete nation MOSFET and PWM controller solution, it can reduce total cost; component count, size, and weight; while simultaneously increasing efficiency, productivity, and system reliability. This device is a basic platform well suited for cost-effective designs of flyback converters.

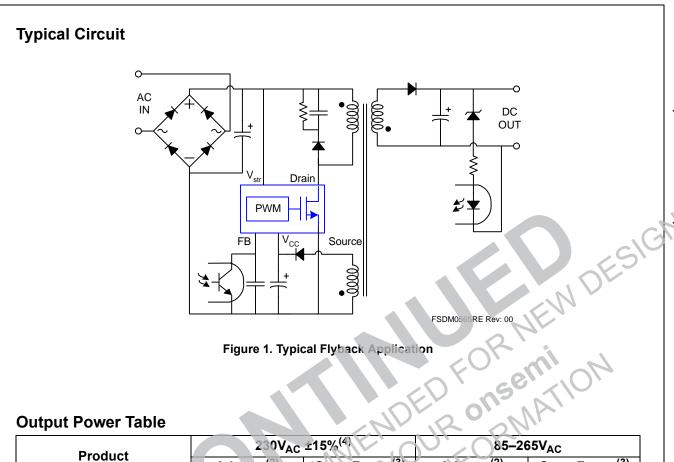
Ordering Information

Product Number	Package	Marking Code	BV _{DSS}	R _{DS(ON)} Max.
FSDM0465REWDTU ⁽¹⁾	TO-220F-6L (Forming)	DM0465RE	650V	2.6 Ω
FSDM0565REWDTU	TO-220F-6L (Forming)	DM0565RE	650V	2.2 Ω
FSDM07652REWDTU	TO-220F-6L (Forming)	DM07652RE	650V	1.6 Ω

Note:

1. WDTU: Forming Type.

All packages are lead free per JEDEC: J-STD-020B standard.



Output Power Table

Product	230V _{AC} ±15% ⁽⁴⁾		85–265V _{AC}	
Floudel	Adapter ⁽²⁾	Open Frame ⁽³⁾	Adapter ⁽²⁾	Open Frame ⁽³⁾
FSDM0465RE	48W	56W	40W	48W
FSDM0565RE	60\W	70W	50W	60W
FSDM07652RE	70W	SOW	60W	70W

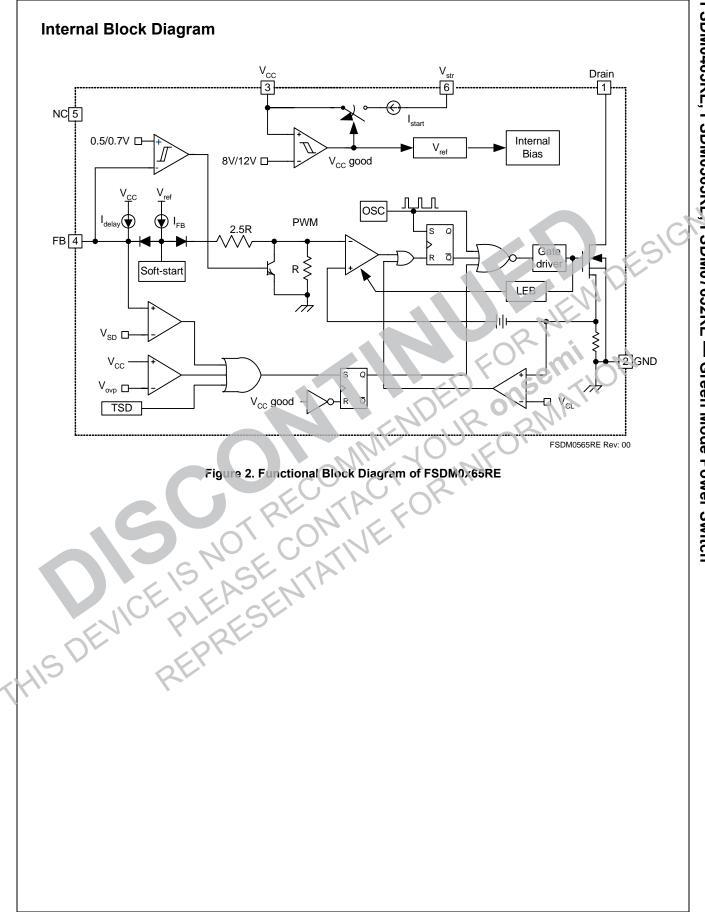
Notes:

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2. Typical continuous power in a non-ventilated enclosed adapter measured at 50°C ambient.

3. Maximum practical continuous power in an open-frame design at 50°C ambient.

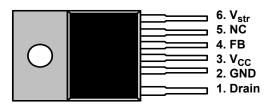
4. 230V_{AC} or 100/115V_{AC} with doubler. FPRES



FSDM0465RE, FSDM0565RE, FSDM07652RE — Green Mode Power Switch

Pin Configuration

TO-220F-6L





Pin Definitions

Pin #	Name	Description
1	Drain	SenseFET drain. This pin is the high-voltage power SenseFET drain. It is de- signed to drive the transformer directly.
2	GND	Ground. This pin is the control ground and the Sensel ET source.
3	Vcc	Power Supply. This pin is the positive supply voltage input. During start-up, the power is supplied by an internal high-voltage current source connected to the V_{str} pin. When V_{CC} reaches 12V, the internal high-voltage current source is disabled and the power is supplied from the auxiliary transformer winding.
4	FB	Fee bac . This pir is internally connected to the inverting input of the PWM comparator. The collector of an opto-coupler is typically tied to this pin. For stable operation, a capacitor should be placed between this pin and GND. If the voltage of this pin reaches 6.0V, the overload protection is activated re-sulting in shutdown of the Power Switch.
5	NC	No Connection.
6	Vsir	Start-up. This pin is connected directly to the high-voltage DC link. At start-up, the internal high voltage current source supplies internal bias and charges the external capacitor connected to the V_{CC} pin. Once V_{CC} reaches 12V, the internal current source is disabled.

FSDM0465RE, FSDM0565RE, FSDM07652RE — Green Mode Power Switch

Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. $T_A = 25^{\circ}$ C, unless otherwise specified.

Symbol	Parameter			Value	Unit
BV _{DSS}	Drain Source Breakdown	Voltage		650	V
V _{str}	Max. Voltage at Vstart pin		650	V	
	FSDM0465RE		T _C =25°C	9.6	
I _{DM}	Drain Current Pulsed ⁽⁵⁾	FSDM0565RE	T _C =25°C	11	A _{DC}
		FSDM07652RE	T _C =25°C	15	
		FSDM0465RE	T _C =25°C	2.2	
		FSDIVI0403RE	T _C =100°C	1.4	
1	Continuous Drain Current FSDM0565RE FSDM07652RE	FORMOTOTOF	T _C =25°C	2.8	
Ι _D		FSDM0565RE	T _C =100°C	1.7	A
			T _C =25°C	3.8	11
	F3DM07032RE		T _C =100°C	2.4	
	Single Pulsed Avalanche Energy ⁽⁶⁾ FSDM0465RE FSDM0565RE FSDM07652RE				
E _{AS}			190	cm -	
			370		
V _{CC}	Supply Voltage			20	V
V _{FB}	Input Voltage Range		- CM-	-0.3 to V _{CC}	V
P _D (Watt H/S)	Total Power Dissipation (T	=25°C)	NH IO	45	W
TJ	Operating Junction Tempe	erature	<u> </u>	Internally limited	°C
Τ _Α	Operating Ambient Tempe	rature	6 2	-25 to +85	°C
T _{STG}	Storage Temperature		-55 to +150	°C	
	ESD Capability, HBM Model (All pins except V _{str} and FB)		2.0 (GND-V _{str} /V _{FB} =1.5kV)	kV	
	ESD Capability, Machine Model			300 (GND-V _{str} /V _{FB} =225V)	V

Notes:

5. Repetitive rating: Pulse width limited by maximum junction temperature.

6. L=14mH, starting T_J=25°C.

Thermal Impedance

 $T_A=25^{\circ}C$, unless otherwise specified.

Symbol	Parameter	Value	Unit
$\theta_{JA}^{(7)}$	Junction-to-Ambient Thermal Resistance	49.90	°C/W
θ _{JC} ⁽⁸⁾	Junction-to-Case Thermal Resistance	2.78	°C/W

Notes:

7. Free-standing, with no heat-sink, under natural convection.

8. Infinite cooling condition - refer to the SEMI G30-88.

Electrical Characteristics

 T_A = 25°C unless otherwise specified.

Symbol	Parameter		Condition	Min.	Тур.	Max.	Uni
SenseFET	SECTION						
		FSDM0465RE	$V_{DS} = 650V, V_{GS} = 0V$			250	
		FSDIVI0405RE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			250	
	Zero Gate Voltage	FSDM0565RE	$V_{DS} = 650V, V_{GS} = 0V$			500	
I _{DSS}	Drain Current	FSDIMUSOSKE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			500	μA
		FSDM07652RE	$V_{DS} = 650V, V_{GS} = 0V$			500	
		T SDM07032ILE	$V_{DS} = 520V, V_{GS} = 0V, T_{C} = 125^{\circ}C$			500	
	Otatia Drain Oauraa	FSDM0465RE			2.20	2.60	C
R _{DS(ON)} Static Drain Source on Resistance ⁽⁹⁾	FSDM0565RE	V _{GS} = 10V, I _D = 2.5A		1.76	2.20	Ω	
		FSDM07652RE			1.40	1.60	
		FSDM0465RE			60		
C _{OSS}	Output Capacitance	FSDM0565RE	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$	1	78		pF
	FSDM07652RE			100			
		FSDM0465RE			23	1	4
t _{d(on)}	Turn-On Delay Time	FSDM0565RE	$V_{DD} = 325 \vee, I_D = 5A$	S	22	O.	ns
		FSDM07652RE			22		
		FSDM0465RE	EN IR	2	20		
t _r	Rise Time	FSDM0565RE	$V_{DD} = 325V, I_D = 5A$		52		ns
		FSDN07652RE	Min Xo MY		60		
		FSDM0465RE			65		
t _{d(off)}	Turn-Off Delay Time	FSDM0565RE	$V_{DD} = 325V, I_D = 5A$		95		ns
		FSDM07652RE			115		
		FSDM0465PE			27		
ίf	Fall Time	FSDM0565RE	$V_{DD} = 325V, I_D = 5A$		50		ns
		FSDM07652RE			65		
CONTROL	SECTION						
fosc	Switching Frequency	65	V _{FB} = 3V	60	66	72	kHz
Δf_{STABLE}	Switching Frequency S	-	$13V \leq V_{CC} \leq 18V$	0	1	3	%
Δf _{OSC}	Switching Frequency	/ariation ⁽¹⁰⁾	$-25^{\circ}C \leq T_A \leq 85^{\circ}C$	0	±5	±10	%
I _{FB}	Feedback Source Cur	rent	V _{FB} = GND	0.7	0.9	1.1	mA
		FSDM0465RE		77	82	87	%
D_{MAX}	Maximum Duty Cycle	FSDM0565RE		77	82	87	%
		FSDM07652RE		75	80	85	%
D _{MIN}	Minimum Duty Cycle					0	%
V _{START}	UVLO Threshold Volta		V _{FB} = GND	11	12	13	V
V _{STOP}			V _{FB} = GND	7	8	9	V
t _{S/S}	Internal Soft-Start Tim	e	V _{FB} = 3		10	15	ms

2

Electrical Characteristics (Continued)

 $T_A = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
BURST M	ODE SECTION					1	<u> </u>
V _{BURH}	Burat Mada Valtagaa		$V_{CC} = 14V$		0.7		V
V _{BURL}	Burst Mode Voltages		$V_{CC} = 14V$		0.5		V
PROTECT	ION SECTION						
V _{SD}	Shutdown Feedback Vol	tage	$V_{FB} \ge 5.5V$	5.5	6.0	6.5	V
IDELAY	Shutdown Delay Current	t	V _{FB} = 5V	2.8	3.5	4.2	μA
t _{LEB}	Leading-Edge Blanking	Time			250		ns
		FSDM0465RE	V _{FB} = 5V, V _{CC} = 14V	1.60	1.80	2.00	C
I _{LIMIT}	Peak Current Limit ⁽¹¹⁾	FSDM0565RE	V _{FB} = 5V, V _{CC} = 14V	2.00	2.25	2.50	A
		FSDM07652RE	V _{FB} = 5V, V _{CC} = 14V	2.20	2.50	2.70	
V _{OVP}	Over-Voltage Protection			18	19	20	V
T _{SD}	Thermal Shutdown Tem	perature ⁽¹⁰⁾		130	145	160	°C
TOTAL DE	EVICE SECTION			8			
I _{OP}			V _{FB} = GND, V _{CC} = 14V			1	4
I _{OP(MIN)}	Operating Supply Currer	nt ⁽¹²⁾	$V_{\text{FB}} = \text{GND}, V_{\text{CC}} = 10\text{V}$	60	2.5	5.0	mA
I _{OP(MAX)}	1		$V_{FB} = GND, V_{CC} = 18V$		0	•	

Notes:

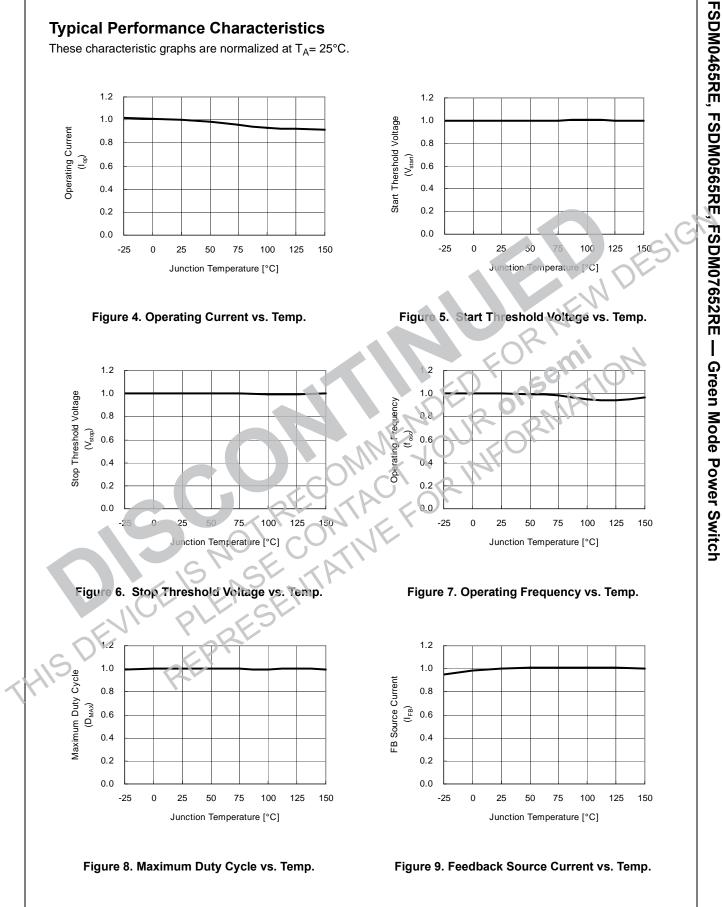
9. Pulse test: Pulse width \leq 300µS, duty cycle \leq 2%.

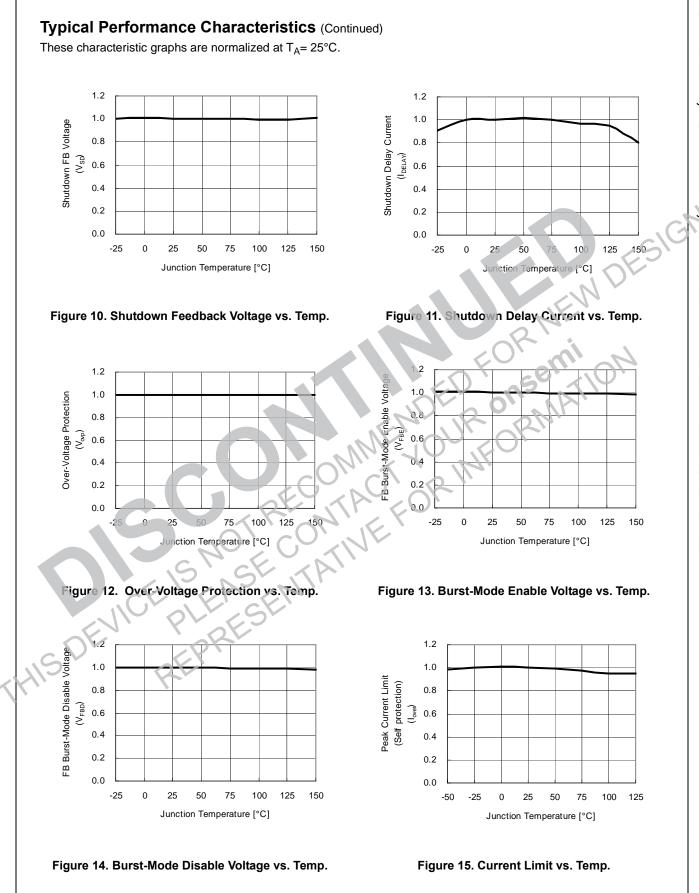
10. These parameters, although guaranteed at the design, are not tested in production.

Comparison Between FS6M0765RTC and FSDM0x65RE

Function	FS6M0765RTC	FSDM0x65RE	FSDM0x65RE Advantages
Soft-Start	Adjustable soft-start time using an external capacitor	Internal soft-start with typically 10ms (fixed)	 Gradually increasing current limit during soft-start reduces peak current and volt- age component stresses Eliminates external soft-start components in most applications Reduces or eliminates output overshoot
	Built into controller	Built into controller	Improves light-load efficiency
Burst-Mode Operation	 Output voltage 	Output voltage fixed	Reduces no-load consumption
	drops to around half		
			ED FOR NE ION
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Functional Description

V_{cc}

8V/12V 🗆

of 1. Start-up: In previous generations Power Switches the V_{CC} pin had an external startup resistor to the DC input voltage line. In this generation, the start-up resistor is replaced by an internal high-voltage current source. At start-up, the internal high-voltage current source supplies the internal bias and charges the external capacitor (C_{vcc}) connected to the V_{CC} pin, as illustrated in Figure 17. When V_{CC} reaches 12V, the FSDM0x65RE begins switching and the internal highcurrent voltage source disabled. The is FSDM0x65RE continues normal switching operation and the power is supplied from the auxiliary transformer winding unless V_{CC} goes below the stop voltage of 8V.

 V_{DC}

Vref

Internal

Bias

SDM0565RE Rev: 0

2.1 Pulse-by-Pulse Current Limit: Because currentmode control is employed, the peak current through the SenseFET is limited by the inverting input of PWM comparator (V_{FB}^*) as shown in Figure 18. Assuming that the 0.9mA current source flows only through the internal resistor (2.5R + R = 2.8k Ω), the cathode voltage of diode D2 is about 2.5V. Since D1 is blocked when the feedback voltage (V_{FB}) exceeds 2.5V, the maximum voltage of the cathode of D2 is clamped at this voltage, thus clamping V_{FB}^* . Therefore, the peak value of the current through the SenseFET is limited.

2.2 Leading Edge Blanking (LEB): At the instant the internal SenseFET is turned on a high-current spike occurs through the SenseFET, caused by primary-side capacitance and secondary-side rectifier reverse recovery. Excessive voltage across the R_{sense} resistor would lead to incorrect reedback operation in the current mode PWM control. To counter this effect, the FSDM0x65RE employs a leading-edge blanking (LEB) circuit. This circuit inhibits the PWM comparator for a short time (t_{LB}) after the SenseFET is turned on.

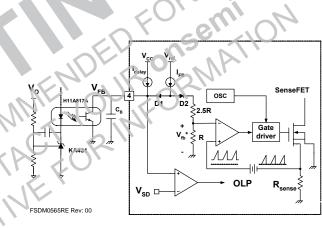


Figure 18. Pulse-Width-Modulation (PWM) Circuit

2. Feedback Control: FSDM0x65RE employs currentmode control, as shown in Figure 18. An opto-coupler (such as the H11A817A) and shunt regulator (such as the KA431) are typically used to implement the feedback network. Comparing the feedback voltage with the voltage across the R_{sense} resistor, plus an offset voltage, makes it possible to control the switching duty cycle. When the reference pin voltage of the shunt regulator exceeds the internal reference voltage of 2.5V, the optocoupler LED current increases, pulling down the feedback voltage and reducing the duty cycle. This event typically occurs when the input voltage is increased or the output load is decreased.

V_{CC} good

Igure 17. Internal Start up Circuit

3. Protection Circuit: The FSDM0x65RE has several self-protective functions, such as overload protection (OLP), over-voltage protection (OVP), and thermal shutdown (TSD). Because these protection circuits are fully integrated into the IC without external components, the reliability is improved without increasing cost. Once a fault condition occurs, switching is terminated and the SenseFET remains off, which causes V_{CC} to fall. When V_{CC} reaches the UVLO stop voltage of 8V, the protection is reset and the internal high-voltage current source charges the V_{CC} capacitor via the V_{str} pin. When V_{CC} reaches the UVLO start voltage of 12V, the FSDM0x65RE resumes normal operation. In this manner, the auto-restart can alternately enable and disable the switching of the power SenseFET until the fault condition is eliminated (see Figure 19).

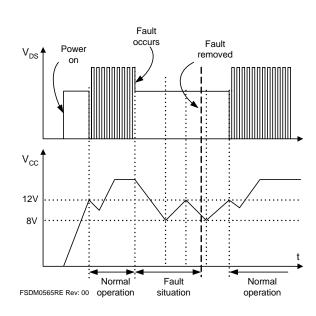
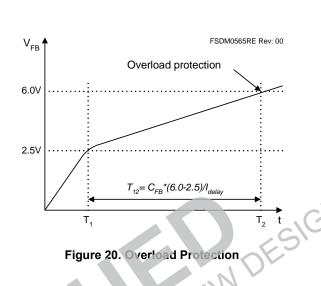


Figure 19. Auto Restart Operation

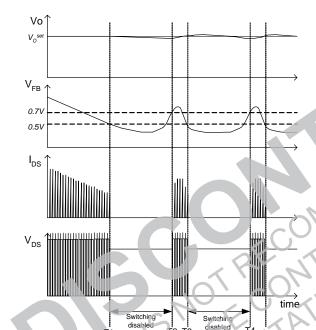
3.1 Overload Protection (OLP): Overload is defined as the load current exceeding a pre-set level due to an unexpected event. In this situation, the protection circuit should be activated to protect the SMPS. Even when the SMPS is in normal operation, the overload protection circuit can be activated during the load transition. To avoid this undesired operation, the overload protection circuit is designed to be activated after a specified time to determine whether it is a transient situation or a true overload situation. Because of the pulse-by-pulse current limit capability, the maximum peak current through the SenseFET is limited, and therefore the maximum input power is restricted with a given input voltage. If the output consumes beyond this maximum power, the output voltage (Vo) decreases below the set voltage. This reduces the current through the optocoupler LED, which also reduces the opto-coupler transistor current, thus increasing the feedback voltage (V_{FB}) . if V_{FB} exceeds 2.5 / D1 is blocked and the 3.5µA current source starts to charge C_B slowly up to V_{CC} . In this condition, V_{FB} continues increasing until it reaches 6V, when the switching operation is terminated, as shown in Figure 20. The delay time for shutdown is the time required to charge C_B from 2.5V to 6.0V with 3.5µA. A 10 ~ 50ms delay time is typical for most applications.

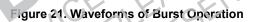


3.2 Over Voltage Protection (OVP): If the secondary side feedback circuit were to malfunction or a solder detect caused an opening in the feedback path, the current through the opto-coupler transistor becomes almost zero. In this event, V_{FB} climbs in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection is activated. Because more energy than required is provided to the output, the output voltage may exceed the raied voltage before the overload protection is activated, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an overvoltage protection (OVP) circuit is employed. In general, V_{CC} is proportional to the output voltage and the FSDM0x65RE uses V_{CC} instead of directly monitoring the output voltage. If V_{CC} exceeds 19V, an OVP circuit is activated, resulting in the termination of the switching operation. To avoid undesired activation of OVP during normal operation, V_{CC} should be designed below 19V.

3.3 Thermal Shutdown (TSD): The SenseFET and the control IC are built in one package. This makes it easy for the control IC to detect the heat generation from the SenseFET. When the temperature exceeds ~150°C, the thermal shutdown is activated.

4. Soft-Start: The FSDM0x65RE has an internal softstart circuit that increases PWM comparator inverting input voltage, together with the SenseFET current, slowly after it starts up. The typical soft-start time is 10ms. The pulse width to the power switching device is progressively increased to establish the correct working conditions for transformers, inductors, and capacitors. The voltage on the output capacitors is progressively increased with the intention of smoothly establishing the required output voltage. It also helps prevent transformer saturation and reduces the stress on the secondary diode during start-up. **5. Burst Operation**: To minimize power dissipation in standby mode, the FSDM0x65RE enters burst-mode operation. As the load decreases, the feedback voltage decreases. As shown in Figure 21, the device automatically enters burst mode when the feedback voltage drops below $V_{BURL}(500\text{mV})$. At this point, switching stops and the output voltages start to drop at a rate dependent on standby current load. This causes the feedback voltage to rise. Once it passes V_{BURH} (700mV), switching resumes. The feedback voltage then falls and the process repeats. Burst-mode operation alternately enables and disables switching of the power SenseFET, thereby reducing switching loss in standby mode.





DM0565RE Rev: 00

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Application Information

Application	Output Power	Input Voltage	Output Voltage (Max. Current)
LCD Monitor	40W	Universal input (85-265V _{AC})	5V (2.0A) 12V (2.5A)

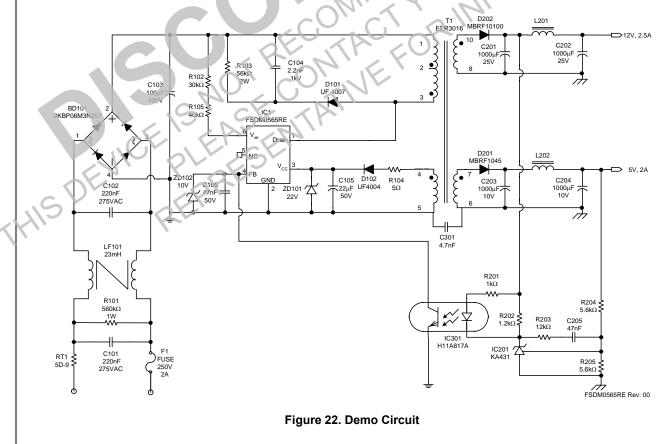
Features

- High efficiency (>81% at 85V_{AC} input)
- Low zero load power consumption (<300mW at 240V_{AC} input)
- Low standby mode power consumption (<800mW at 240V_{AC} input and 0.3W load)
- Low component count
- Enhanced system reliability through various protection functions
- Internal soft-start (10ms)

Key Design Notes

- Resistors R102 and R105 are employed to prevent start-up at low input voltage. After start-up, there is no power loss in these resistors since the start-up pin is internally disconnected after start-up.
- The delay time for overload protection is designed to be about 50ms with C106 of 47nF. If a faster triggering of OLP is required, C106 can be reduced to 10nF.
- Zener diode ZD102 is used for a safety test, such as UL. When the drain pin and feedback pin are shorted, the zener diode fails and remains short, which causes the fuse (F1) to be blown and prevents explosion of the opto-coupler (IC301). This zener diode also increases the immunity against line surge.





2. Transformer

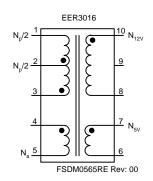


Figure 23. Transformer Schematic Diagram

3. Winding Specification

		N _a <u>5</u> II C FSDM0565	RE Rev: 00	
3. Winding	F Specification	igure 23. Transformer S	Schematic Di	agram
No	Pin (s→f)	Wire	Turns	Winding Method
N _a	4 → 5	0.2 [¢] × 1	8	Center Winding
Insulation: P	olyester Tape t = 0.050r	nm, 2 Layers		O NA
N _p /2	$2 \rightarrow 1$	$0.4^{\phi} \times 1$	18	Solenoid Winding
Insulation: P	olyester Tape t = 0.050r	nm, 2 Layers	NY IC	0.00
N _{12V}	10 → 8	$0.3^{\varphi} \times 3$	7	Center Winding
Insulation: P	olyester Tape t = 0.050r	nm, 2 Lavers	\mathcal{O}	2 4
N _{5V}	$7 \rightarrow 6$	$0.3^{\phi} \times 3$	30	Center Winding
Insulation: P	olyester Tape t = 0.050r	nm, 2 Layers		
N _p /2	$3 \rightarrow 2$	$0.4^{\circ} \times 1$	18	Solenoid Winding
Outer Insula	tion: Polyester Tape t =	0.050mm, 2 Layers		

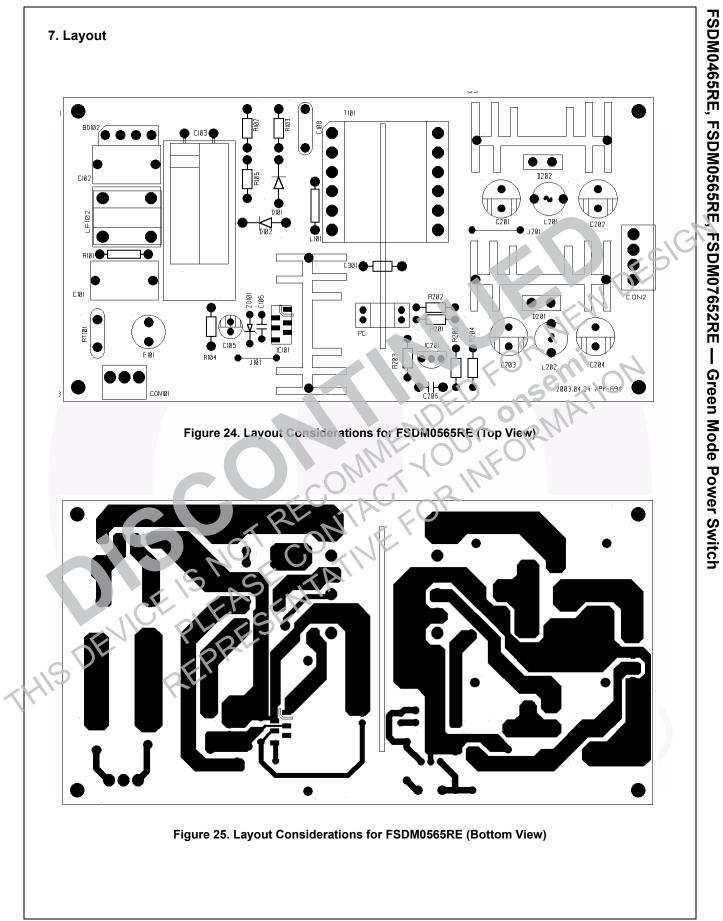
Outer Insulation: Polyester Tape 1	: = 0.050mm, 2 Laye	rs	
4. Electrical Characteristics	ASENI		
	Pin	Specification	Remarks
Inductance	1 - 3	520µH ± 10%	100kHz, 1V
Leakage Inductance	1 - 3	10µH Max	2 nd all short

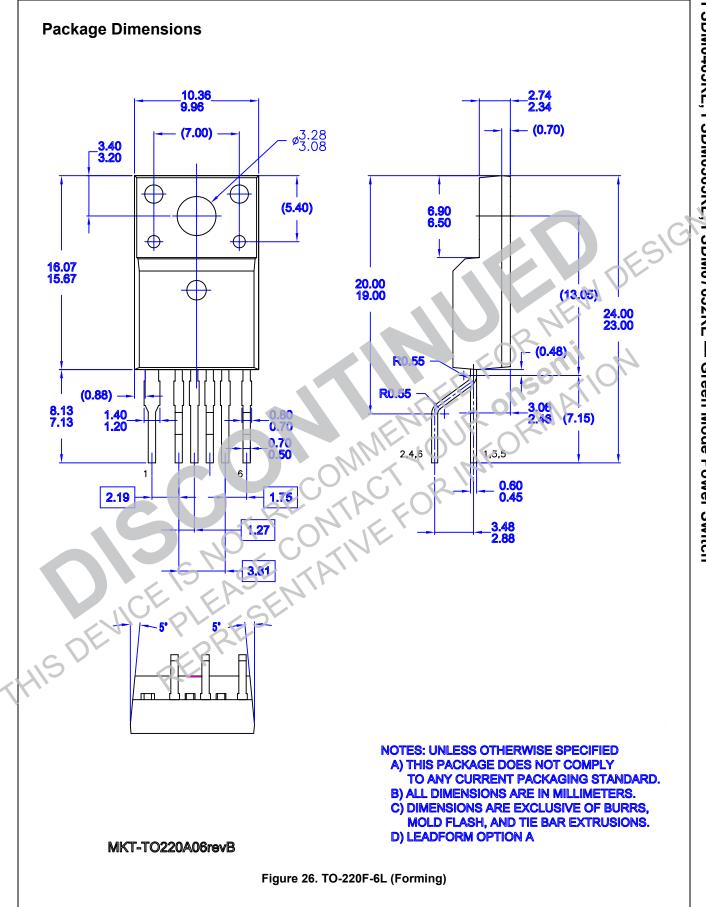
5. Core & Bobbin

- Core: EER 3016
- Bobbin: EER3016
- Ae(mm2): 96

6. Demo Circuit Part List

Part	Value	Note	Part	Value	Note
	Fu	Se	D102	UF4004	
F101	2A/250V		D201	MBRF1045	
			D202	MBRF10100	
	NT	C	ZD101	Zener Diode	22V
RT101	5D-9		ZD102	Zener Diode	10V
	Resi	stor		Bridge	Diode
R101	560kΩ	1W	BD101	2KBP06M 3N257	Bridge Diode
R102	30kΩ	1/4W			
R103	56kΩ	2W		Line	Filter
R104	5Ω	1/4W	LF101	23mH	Wire 0.4mm
R105	40kΩ	1/4W			
R201 1kΩ 1/4W					2
R202	1.2kΩ	1/4W	IC101	FSDM0565RE	Power S v.tch (5A,650V)
R203	12kΩ	1/4W	IC201	KA431 (TL431)	Voltage reference
R204	5.6kΩ	1/4W	IC301	H11A817A	Opto-coupler
R205	5.6kΩ	1/4W		10.00	
C102 C103 C104 C105 C106 C201 C202 C203 C204 C205 C301	220nF/275 V _{AC} 100µF/400V 2.2nF/1kV 22µF/50V 47nF/50V 1000µF/25V 1000µF/10V 1000µF/10V 47nF/50V 4.7nF	Box Capacitor Electrolytic Capacitor Ceramic Capacitor Flectrolytic Capacitor Electrolytic Capacitor Electrolytic Capacitor Electrolytic Capacitor Electrolytic Capacitor Ceramic Capacitor Ceramic Capacitor Polyester Film Cap. ctor	NE	NOUR YOUR OR INF	
L201	5µH	Wire 1.2mm	1		
L201	5μH	Wire 1.2mm			
	Dio		-		
	Dio				





FSDM0465RE, FSDM0565RE, FSDM07652RE I **Green Mode Power Switch**

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